



AF 11768

PATENT

ATTY. DOCKET NO.: P66182US0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re App. of:

Young-Hee MUN

Group Art Unit: 1765

Serial No.: 09/742,127

Examiner: M. Song

Filed: December 22, 2000

For: METHOD FOR TREATING A SEMICONDUCTOR WAFER THERMALLY  
AND SEMICONDUCTOR WAFER FABRICATED BY THE SAME

## TRANSMITTAL

Commissioner for Patents  
Mail Stop AF  
P.O. Box 1450  
Alexandria, VA 22313-1450RECEIVED  
OCT 24 2003  
TC 1700

Sir:

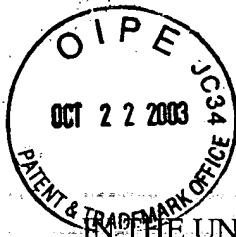
Transmitted herewith is an Amendment Under Rule 1.116 for filing in the above-captioned patent application.

The fee has been calculated as shown below:

	Claims Remaining After Amendment	Highest Number Previously Paid For	Present Extra	Small Entity Rate Addit. Fee	(or)	Other Than A Small Entity Rate Addit. Fee
Total	02	-	23 =	x 09 = \$		x 18 = \$
Indep.	02	-	07 =	x 42 = \$		x 84 = \$
First Presentation of Multiple Dependent Claims				+130 = \$		+ 260 = \$
Total Additional Fee				\$		\$

XXXX If a Petition for Extension of Time is necessary and the Petition and/or the check is not enclosed, this will act as the Petition and applicant herewith petitions the Commissioner to extend the time for response and charge any fees necessary under 37 CFR 1.17 (a)(1)-(5) to Deposit Account No. 06-1358. The Commissioner is also authorized to charge payment of any other additional fees associated with this communication or credit any overpayment to Deposit Account No. 06-1358. A duplicate copy of this sheet is attached.

Respectfully submitted,  
JACOBSON HOLMAN PLLCBy: Yoon S. Ham  
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Washington, D.C. 20004-2201  
Atty. Docket: 12597/P66182US0  
Telephone: (202)638-6666  
Date: October 22, 2003  
YSH:SCB  
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***AMENDMENT UNDER RULE 1.116***

Commissioner for Patents  
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P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Final Office Action (Paper No. 13) dated July 23, 2003, kindly  
amend the above-identified patent application as set forth herein.

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